



Customer Information Notification

201706004I

Issue Date: 23-Jun-2017
Effective Date: 24-Jun-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Change Category

- | | | | | |
|--|---|--|---|--|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input checked="" type="checkbox"/> Electrical spec./Test coverage |

MPC5746C Rev 5.1
Datasheet
Announcement

Information Notification

NXP Semiconductor is announcing the release of MPC5746C Rev 5.1 datasheet. A full description of updates to this new Datasheet can be found in the attached supplemental information. The revision history included in the updated document also provides a detailed description of the changes. Datasheet is attached.

The updated document can be found at <http://www.nxp.com>. Search for MPC5746C.

Why do we issue this Information Notification

Minor errors were discovered after the rev 5.0 datasheet was released. Changes include fixing typos, modifying some notes, and update of the revision history.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

No impact to existing inventory.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Josef Sigmund
Position NXP product engineer Automotive Microcontrollers and Processors
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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
SPC5746CSK1MMJ6	935312542557	SPC5746CSK1MMJ6	32 BIT,3M FLASH,384 RAM	LBGA256	RFS	BL Auto Micro Processors
SPC5746CSK1MKU6	935322183557	SPC5746CSK1MKU6	"32 BIT,3M FLASH,384 RAM"	HLQFP176	RFS	BL Auto Micro Processors
SPC5746CSK1MMH6	935316141557	SPC5746CSK1MMH6	"32 BIT,3M FLASH,384 RAM"	LBGA100	RFS	BL Auto Micro Processors